

# MS U1 N60

## 600V N-Channel MOSFET

#### Description

The MSU1N60 is a N-channel enhancement-mode MOSFET, providing the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness. The TO-251 package is universally preferred for all commercial-industrial applications

#### Features

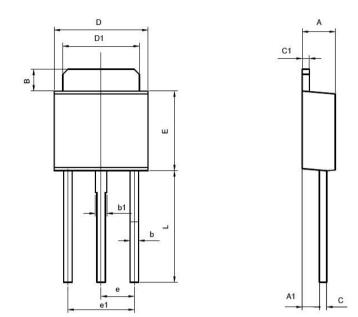
- Originative New Design
- Very Low Intrinsic Capacitances
- Excellent Switching Characteristics
- Unrivalled Gate Charge : 17nC (Typ.)
- Extended Safe Operating Area
- Lower RDS(ON) : 8.50 Ω (Typ.) @VGS=10V
- 100% Avalanche Tested
- RoHS compliant package

#### Packing & Order Information

80/Tube ; 4,000/Box

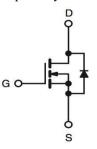






	Dimens	ions in	Dimensions in		
	Millim	eters	Inches		
Symbol	min	max	min	max	
А	2.15	2.45	0.85	0.96	
A1	1.00	1.40	0.39	0.55	
В	1.25	1.75	0.49	0.69	
b	0.45	0.75	0.18	0.3	
b1	0.65	0.95	0.26	0.37	
С	0.38	0.64	0.15	0.25	
C1	0.38	0.64	0.15	0.25	
D	6.30	6.70	2.48	2.64	
D1	5.10	5.50	2.01	2.17	
Е	5.30	5.70	2.09	2.24	
e	2.3 (1	typ.)	0.91 (typ.)		
e 1	4.4	4.8	1.73	1.89	
L	7.4	8.0	2.91 3.15		

Graphic symbol





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#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)						
Symbol	Parameter	Value	Unit			
V <sub>DSS</sub>	Drain-Source Voltage	600	V			
V <sub>GS</sub>	Gate-Source Voltage	±30	V			
Ір	Drain Current -Continuous (TC=25°C)	1	А			
ID.	Drain Current -Continuous (TC=100°C)	0.65	А			
IDM	Drain Current Pulsed	4	А			
E <sub>AS</sub>	Single Pulsed Avalanche Energy	52	mJ			
E <sub>AR</sub>	Repetitive Avalanche Energy	3	mJ			
dV/dt	Peak Diode Recovery dV/dt	4.5	V/ns			
D	Power Dissipation (TC = $25 \ ^{\circ}$ C)	30	W			
P <sub>D</sub>	- Derate above 25°C	0.23	W/°C			
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150	°C			
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	300	°C			

•Drain current limited by maximum junction temperature

Thermal Resistance Characteristics						
Symbol	Parameter	Max.	Units			
Rөлс	Junction-to-Case	4.2	°C/W			
R <sub>θJA</sub>	Junction-to-Ambient	85.3				

On Characteristics							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
V <sub>GS</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS} \ , \ I_D=250 \mu A$	2.0		4.0	V	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = 10 V$ , $I_D = 5 A$		8.5	10	Ω	

Off Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}=0~V$ , $I_{D}\text{=}250\mu\text{A}$	600			V
$\Delta BV_{DSS}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , Referenced to $25^{\circ}C$		0.4		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V} V_{DS} = 480 \text{ V}, T_C = 125^{\circ}\text{C}$			10 100	μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	$V_{GS}=30\ V\ ,\ V_{DS}=0\ V$			100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \ V \ , \ V_{DS} = 0 \ V$			-100	nA



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Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units
t <sub>d(on)</sub>	Turn-On Time			15	35	ns
t <sub>r</sub>	Turn-On Time	$V_{DS} = 300 V, I_D = 1 A,$		75	140	ns
$t_{d(off)}$	Turn-Off De la y Time	$R_G = 25 \ \Omega$		30	60	ns
tf	Turn-Off Fall Time			35	60	ns
Qg	Total Gate Charge	$ V_{DS} = 480 \text{ V}, I_D = 1 \text{ A}, $ $ V_{GS} = 10 \text{ V} $		7.5	9	nC
Q <sub>gs</sub>	Gate-Source Charge			1		nC
$Q_{gd}$	Gate-Drain Charge			3		nC
C <sub>ISS</sub>	Input Capacitance			174	340	pF
Coss	Output Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$ 		185	370	pF
C <sub>RSS</sub>	Reverse Transfer Capacitance			80	160	pF

Source-Drain Diode Maximum Ratings and Characteristics							
Symbol	Parameter	Test Conditions	Min	Typ.	Max.	Units	
Is	Continuous Source-Drain Diode Forward Current1.0		1.0				
I <sub>SM</sub>	Pulsed Source-Drain Diode Forward Current				4.0	A	
V <sub>SD</sub>	Source-Drain Diode Forward Voltage	$I_S = 1 A, V_{GS} = 0 V$			1.4	V	
trr	Reverse Recovery Time	$I_S = 1 A$ , $V_{GS} = 0 V$		420		ns	
Qrr	Reverse Recovery Charge	$diF/dt = 100A/\mu s$		0.42		μC	

Notes;

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L=95mH, I\_{AS}=1.0A, V\_{DD}=50V, R\_G=50\Omega, Starting T\_J=25 $^\circ\!\mathrm{C}$ 

3. Isp $\leq$ 1.0A, di/dt $\leq$ 300A/ $\mu$ s,V<sub>DD</sub> $\leq$ BV<sub>DSS</sub>, Starting T<sub>J</sub>=25°C

4. Pulse Test: Pulse Width  $\leq 300 \,\mu \,\mathrm{s}$ , Duty Cycle  $\leq 2\%$ 

5. Essentially Independent of Operating Temperature



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